<u>REMARKS</u>

By the present amendment, claims 1, 2, 4 and 6 have been amended to obviate the

objections thereto and/or to further clarify the concepts of the present invention. Support

for the claim amendments to claims 1 and 2 may be found on page 3, lines 3-10 and lines

30-31 and page 6, lines 2-7 of the subject specification. Claims 1-4 and 6 still are pending.

Entry of these amendments are respectfully requested.

Claim 4 was objected to for being a multiple dependent claim which is dependent

upon a multiple dependent claim. Claim 6 was objected to as being dependent upon a

cancelled claim.

With regard to the former, it would appear that the Amendment dated February 26,

2004, inaccurately transcribed claim 4 as this claim was amended in Amendment dated

November 17, 1999, to be dependent upon claim 1 or 2. As to the latter, claim 6 has been

amended to be dependent upon claim 1. Withdrawal of the objections is respectfully

requested.

Claims 1-3 were rejected under 35 USC § 103(a) as being unpatentable over the

patent to Mori et al in view of the patent to Kawagoe et al. As before, it basically was

asserted that the cited Mori et al patent teaches Al-Si or Al-Si-Sn compositions with ranges

for disclosed components overlapping those as claimed in independent claims 1 and 2 and

which have the ratio of the short diameter to the long diameter as claimed. With regard to

the claim limitation of the particle size greater than 10 µm, it was asserted that (1) the

comparative example teaches such particles and further that (2) the Mori et al patent

teaches that these particles are undesirable in the specifically disclosed materials. From

the latter statement (2), it was further presumed that such materials actually had been

made by the inventors of the cited patent.

It was acknowledged in the rejection that the Mori et al patent does not teach the

use of (a) HVOF flame spraying of applying the alloy and (b) surface roughening of the

substrate by shot blasting. As to the former (a), it was alleged that the HVOF is a well

known form of thermal spraying as taught by the Mori et al patent. As to the latter (b), the

cited patent to Kawagoe et al was asserted to provide this deficiency. Reconsideration of

this rejection in view of the above claim amendments and the following comments is

respectfully requested.

It is submitted that the amendments to claims 1 and 2 made herein help to

distinguish these claims over the teachings of the cited patents, particularly the patent to

Mori et al. More specifically, these amendments recite that, since a part of the Al-Si

powder does not melt during flame-spraying, the original structure of the powder remains

in a portion of the flame-sprayed layer, in such a manner that the primary and eutectic Si

particles remain in the flame-sprayed layer.

Particularly in this regard, the attention of the examiner is directed to the attached

Table where the significance of this distinction is detailed by comparing Al-Si alloys

according to (A) a conventional method, (B) the subject invention and (C) the Mori et al

patent. The Mori et al patent refers to a cast Al-Si alloy at column 1, lines 22-40 and

column 3, lines 28-31 as prior art and is therefore construed to avoid formation the

unmelted Al-Si structure. The Mori et al patent further discloses at column 2, lines 29 and

30 that "Si is forcedly solid solubilized in Al matrix." Consequently, this is a principle of the

disclosure of the Mori et al patent and is therefore an important teaching of the patent. It

must be emphasized that this teaching of the Mori et al patent is contradictory to formation

of the unmelted Al-Si structure in accordance with the present invention and as now recited

in independent claims 1 and 2.

It is submitted that the above-noted teaching deficiencies of the Mori et al patent are

not supplied by the cited Kawagoe et al patent. The Kawagoe et al patent discloses

mixture of melted Cu alloy-structure and unmelted Cu-alloy structure. However, the

Kawagoe et al patent teaches to leave a portion of the copper alloy, particularly Cu-Pb

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alloy, unmelted so as to utilize the spherical Pb phase for enhancing the compatibility and

therefore the patent does not teach to leave a portion of the Al alloy unmelted. The

Kawagoe et al patent therefore does not disclose to utilize the primary and eutectic Si for

enhancing the load resistance.

The load resistance herein generally means that d/L, in which a bearing is subjected

to load (L) of the shaft at true contact area and deforms by an amount (d). Since the

elastic coefficient is expressed by stress/strain, the load resistance is inverse value of the

elastic coefficient. When the load resistance is low, the bearing greatly deforms under load

so that the fatigue may occur. In addition, seizure is liable to occur because of deformation

and fatigue.

For the reasons stated above, withdrawal of the rejection under 35 U.S.C. § 103(a)

and allowance of claims 1 through 3 as amended over the cited patents are respectfully

requested.

In view of the foregoing, it is submitted that the subject application is now in

condition for allowance and early notice to that effect is earnestly solicited.

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In the event this paper is not timely filed, the undersigned hereby petitions for an appropriate extension of time. The fee for this extension may be charged to Deposit Account No. 01-2340, along with any other additional fees which may be required with respect to this paper.

Respectfully submitted,

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Enclosure: Table

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